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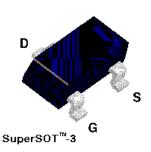
# oN Semiconductor® NDS356AP P-Channel Logic Level Enhancement Mode Field Effect Transistor

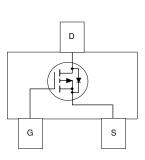
### **General Description**

SuperSOT<sup>™</sup>-3 P-Channel logic level enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications such as notebook computer power management, portable electronics, and other battery powered circuits where fast high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

### Features

- -1.1 A, -30 V,  $R_{DS(ON)} = 0.3 \Omega$  @  $V_{GS} = -4.5 V$  $R_{DS(ON)} = 0.2 \Omega$  @  $V_{GS} = -10 V$ .
- Industry standard outline SOT-23 surface mount package using proprietary SuperSOT<sup>™</sup>-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.





## **Absolute Maximum Ratings** $T_{4} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		NDS356AP	Units
V <sub>DSS</sub>	Drain-Source Voltage		-30	V
$V_{GSS}$	Gate-Source Voltage - Continuous		±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous	(Note 1a)	±1.1	А
	- Pulsed		±10	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
T_,T <sub>stg</sub>	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambien	t (Note 1a)	250	°C/W
R <sub>ØJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			Т <sub>Ј</sub> =55°С			-10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}},  I_{\text{D}} = -250 \; \mu\text{A}$		-0.8	-1.6	-2.5	V
			T <sub>J</sub> =125°C	-0.5	-1.3	-2.2	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.1 \text{ A}$			0.25	0.3	Ω
			T_=125°C		0.35	0.4	
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -1.3 A			0.14	0.2	
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-3			Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -1.1 A$			2		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz			280		pF
C <sub>oss</sub>	Output Capacitance				170		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				65		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 50 \Omega$			8	15	ns
ţ,	Turn - On Rise Time				17	30	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				53	90	ns
t <sub>r</sub>	Turn - Off Fall Time				38	80	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -10 V, I_{D} = -1.1 A,$			3.4	4.4	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -5 V$			0.7		nC
Q <sub>gd</sub>	Gate-Drain Charge				1.5		nC

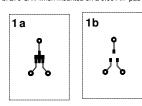
Electrical Characteristics (T <sub>A</sub> = 25°C unless otherwise noted)									
Symbol	Parameter	Conditions	Min	Тур	Max	Units			
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS									
I <sub>s</sub>	Maximum Continuous Source Current				-0.42	А			
I <sub>sm</sub>	Maximum Pulsed Drain-Source Diode Forward Current				-10	А			
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = -0.42 \ ({\rm Note}\ 2)$		-0.8	-1.2	V			

Notes:
1. R<sub>eux</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>euc</sub> is guaranteed by design while R<sub>euc</sub> is determined by the user's board design.

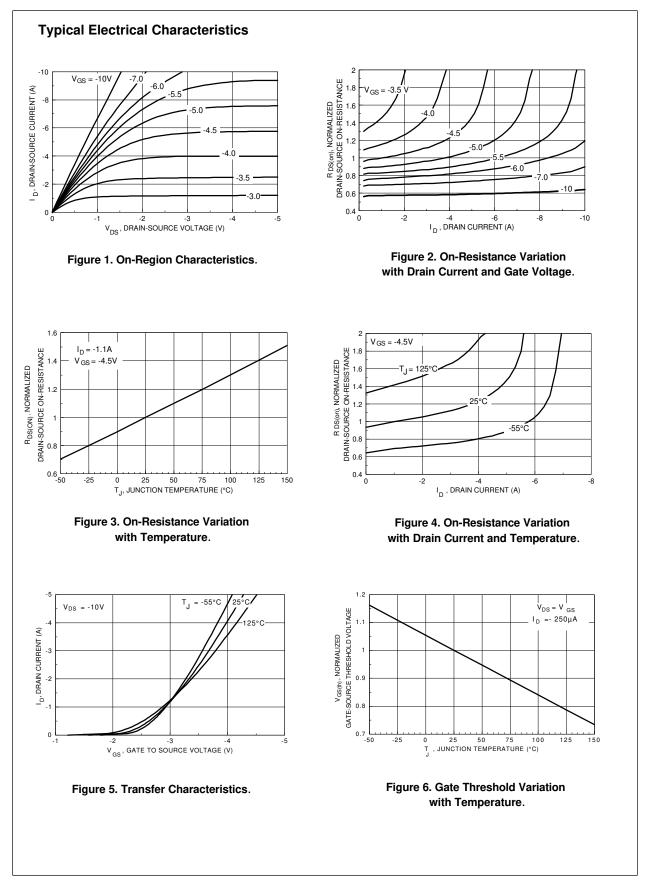
 $P_D(t) = \frac{T_J - T_A}{R_{\theta JA}(t)} = \frac{T_J - T_A}{R_{\theta JC} + R_{\theta CA}(t)} = I_D^2(t) \times R_{DS(ON)@T_J}$ 

Typical  $\rm R_{_{BM}}$  using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment: a.  $250^{\circ}$ C/W when mounted on a 0.02 in<sup>2</sup> pad of 2oz copper.

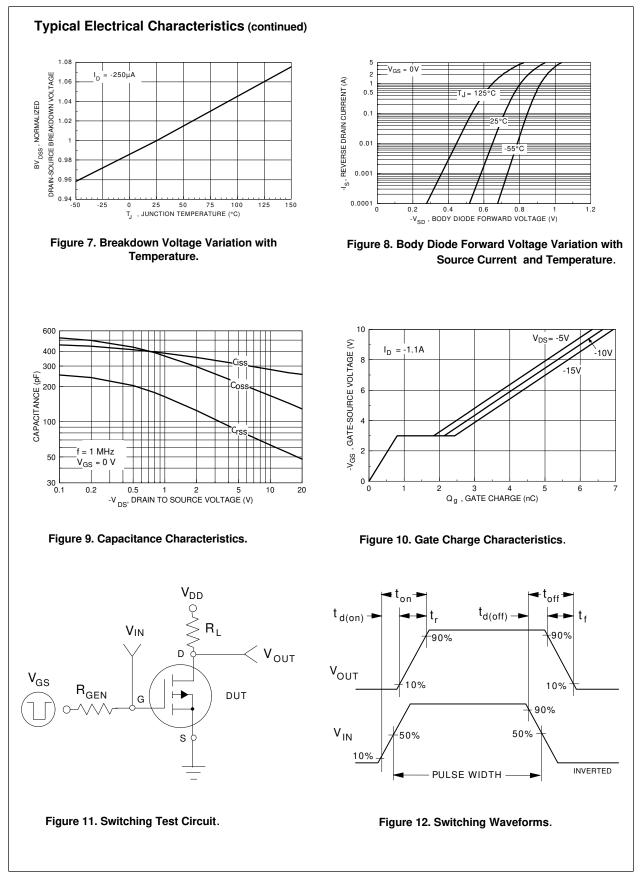
b. 270°C/W when mounted on a 0.001 in² pad of 2oz copper.



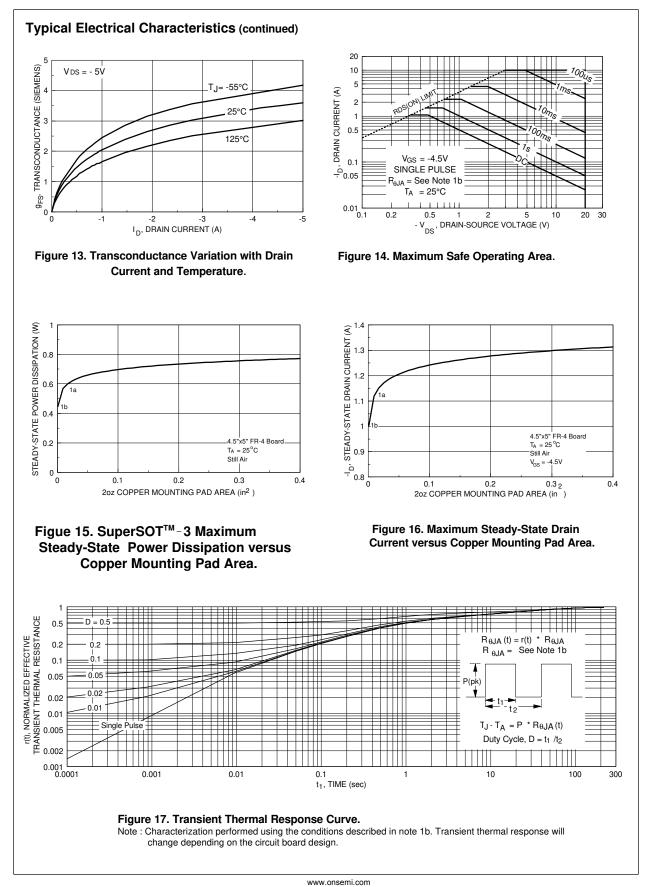
Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.



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